PCN Number:		201	20191121000			PCN Date:	Nov. 21, 2019					
Title: Datasheet for LM48511												
Cus	tomer Contact:	PCN	PCN Manager				D			Quality Services		
Cha	nge Type:											
	Assembly Site				Design				Wafer	Bump Site		
Assembly Process			\boxtimes	Data Sheet					Bump Material			
Assembly Materials				Part number change					Bump Process			
Mechanical Specification			Щ	Test Site			Щ.		Fab Site			
Packing/Shipping/Labeling				Test Process			<u>Щ</u>		Fab Materials			
								Wafer	Fab Process			
Notification Details												
Description of Change:												
Texas Instruments Incorporated is announcing an information only notification.												
The product datasheet(s) is being updated as summarized below.												
The following change history provides further details.												
TEXAS LM48511												
INSTRUMENTS LM48511 SNAS416K ILLY 2007, DEVISED NOVEMBED 2010												
SNAS416K – JULY 2007 – REVISED NOVEMBER 2019												
Changes from Revision J (October 2017) to Revision K												
• (Changed pin labels in Figure 24											
The datasheet number will be changing.												
Device Family			····· 5 6 6			Change From:			Change To:			
,				SNAS416L				SNAS4				
LM48511								2				
Thes	se changes may be	e revie	wed at	the	datasheet	links provide	d.					
http://www.ti.com/product/LM48511												
Reason for Change:												
To accurately reflect device characteristics.												
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):												
No anticipated impact. This is a specification change announcement only. There are no changes												
to the actual device.												
Changes to product identification resulting from this PCN:												
None.												
Proc	duct Affected:											
	48511SO/NOPB	1.5.7	1485119	· O V /	NODP							
1 L L IVI4	+0.11.10U/INUPD	LIV	LHOJII)	$\cup \wedge /$	INUED				1			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.